Finite Element Simulations of Thin-Film Composite BAW Resonators

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Abstract—A finite element method (FEM) formulation is presented for the numerical solution of the electroelastic equations that govern the linear forced vibrations of piezoelectric media. A harmonic time dependence is assumed. Both of the approaches, that of solving the field problem (harmonic analysis) and that of solving the corresponding eigenvalue problem (modal analysis), are described.

A FEM software package has been created from scratch. Important aspects central to the efficient implementation of FEM are explained, such as memory management and solving the generalized piezoelectric eigenvalue problem. Algorithms for reducing the required computer memory through optimization of the matrix profile, as well as Lanczos algorithm for the solution of the eigenvalue problem are linked into the software from external numerical libraries.

Our FEM software is applied to detailed numerical modeling of thin-film bulk acoustic wave (BAW) composite resonators. Comparison of results from 2D and full 3D simulations of a resonator is presented. In particular, 3D simulations are used to investigate the effect of the top electrode shape on the resonator electrical response. The validity of the modeling technique is demonstrated by comparing the simulated and measured displacement profiles at several frequencies. The results show that useful information on the performance of the thin-film resonators can be obtained even with relatively coarse meshes and, consequently, moderate computational resources.

I. INTRODUCTION

A ccurate modeling of piezoelectric devices requires, in general, the application of numerical methods. This is due to the complexity of the piezoelectric equations that describe the device and its loading conditions, rendering analytical solutions of the equations for nontrivial 2D and 3D geometries exceedingly difficult. A general purpose, computer-aided numerical method for predicting the behavior of a physical system in response to external loads is the FEM [1]–[3]. The method is well established and has been widely used in numerous engineering disciplines. The general FEM formulation for linear piezoelectric materials was elaborated by Allik and Hughes [4]. Since then, FEM has been extensively applied in the simulation of piezoelectric devices, such as ultrasonic transducers [5], [6], surface acoustic wave (SAW) devices [7], [8], Lamb wave delay lines [9], and BAW resonators [10]. In this paper, we employ FEM in simulations of thin-film BAW resonators.

The main challenge in the design of thin-film resonators is the suppression of side resonances that can be excited around the frequency of the desired mode, e.g., the funda-
The spurious mode content depends on the geometry of the device, such as the thickness-to-width ratio. For large thickness-to-width ratios, 1D modeling [18]–[21] is considered to be adequate. For modeling in 2D, the mode-matching technique [22], [23], the finite difference frequency domain method [24], [25], and the FEM [26], [27] have been employed. 2D models are considered to be adequate for configurations with narrow and long electrodes [28], such as monolithic crystal filters (MCF). However, the electrode dimensions dictated by electrical matching often are such that accurate results do not warrant 1D or 2D modeling. Therefore, we have studied the spurious resonances through full 3D FEM simulations.

Although FEM tends to be computationally intensive, the trend of constantly increasing speed and memory resources of modern computers favors FEM over faster simulation techniques that rely on more restrictive simplifications and approximations. Because FEM is a strictly numerical technique, it may provide somewhat limited insight into the underlying physics. However, the strong benefit of FEM is in its innate capability to accommodate complicated geometries, different materials, piezoelectric, and full crystal anisotropy. Hence, only few simplifying approximations are required, resulting in a precise and flexible simulation technique.

In this paper, we briefly review the FEM formulation for linear forced piezoelectric vibrations using two approaches: 1) the harmonic analysis in which sinusoidal excitation and, consequently, sinusoidal variation of all of the fields are assumed and 2) a modal analysis in which the generalized piezoelectric eigenvalue problem is solved, resulting in the natural frequencies and associated mode shapes within the frequency range of interest. Next, implementation aspects are discussed, such as the memory management method and solution algorithms, which are essential for reducing the required computational effort.

The FEM analysis is applied to membrane-type resonator models, and it is found that only 3D modeling permits detailed information on the pertinent rich mode spectra. Next, the effects of the top electrode geometry on the resonator behavior are studied, which also calls for full 3D analysis. To validate the modeling technique, simulated displacement profiles for resonators featuring square and circular top electrode shapes are compared with those measured from SMR using laser interferometry [29].

II. Finite Element Formulation for Linear Forced Vibrations of Piezoelectric Materials

The present section briefly summarizes the essential equations in the FEM formulation for piezoelectric media. For details, see [30], [31]. The governing equations are

\[
\nabla \cdot \mathbf{T} + \mathbf{f} = \rho \ddot{\mathbf{u}} \quad \text{and} \quad \nabla \cdot \mathbf{D} = \sigma
\]

(1)

(2)

where \( \rho \) is the density [kg/m\(^3\)], \( \mathbf{T} \) is the mechanical stress tensor [N/m\(^2\)], \( \mathbf{f} \) denotes the mechanical body force [N/m\(^3\)], \( \mathbf{D} \) is the electric displacement vector [C/m\(^2\)], \( \mathbf{u} \) is the mechanical displacement vector [m], and \( \sigma \) abbreviates the (free) volume charge density [C/m\(^3\)].

The piezoelectric constitutive equations that couple the mechanical and electrical quantities in the piezoelectric material are expressed using the abbreviated matrix notation as [32], [33].

\[
\mathbf{T}_{6 \times 1} = \mathbf{c}_{6 \times 6}^E \mathbf{S}_{6 \times 1} + \mathbf{e}_{6 \times 3}^T \nabla \phi_{3 \times 1} \quad \text{and} \quad \mathbf{D}_{3 \times 1} = \mathbf{e}_{3 \times 6} \mathbf{S}_{6 \times 1} - \mathbf{e}_{3 \times 3}^S \nabla \phi_{3 \times 1}
\]

(3)

(4)

where \( \mathbf{T} \) is the stress column, \( \mathbf{S} \) the strain column, \( \phi \) the electric potential [V], \( \mathbf{e} \) the piezoelectric matrix [C/m\(^2\)], \( \mathbf{c}^E \) the elastic stiffness matrix (evaluated at constant electric field) [N/m\(^2\)], and \( \mathbf{e}^S \) is the dielectric permittivity matrix (evaluated at constant strain) [F/m]. The superscript \( T \) denotes the transpose of a matrix. Because the velocity of the electromagnetic wave is five orders of magnitude higher than that of the acoustic wave, the quasi-static approximation \( \mathbf{E} = -\nabla \phi \) for the electric field \( \mathbf{E} [V/m] \) may be used in (3) and (4) with \( \nabla = (\partial/\partial x_1, \partial/\partial x_2, \partial/\partial x_3)^T \).

The strain column is related to the mechanical displacement vector \( \mathbf{u} \) through

\[
\mathbf{S} = \nabla_{S} \mathbf{u}
\]

(5)

where

\[
\nabla_{S} = \begin{bmatrix}
\frac{\partial}{\partial x_1} & 0 & 0 \\
0 & \frac{\partial}{\partial x_2} & 0 \\
0 & 0 & \frac{\partial}{\partial x_3}
\end{bmatrix}
\]

(6)

For a unique solution, the mechanical (for displacement or stress) and electrical (for electric potential or electric displacement) boundary conditions need to be imposed on the entire boundary of the problem domain. The boundary conditions, together with (1)–(6), then completely determine the motion of the piezoelectric material. Alternative equivalent representation of this boundary value problem is in terms of Hamilton’s variational principle [34], [35]. This is especially useful in the derivation of various approximate formulations (see [36] and [37]).

A. Discretization

Consider a volume \( V \) constituting the problem domain as illustrated in Fig. 2 for a BAW resonator. In FEM, the physical problem domain \( V \) is discretized, i.e., subdivided into small elementary volumes called elements. The continuous field quantities—the three components of the mechanical displacement \( u_i, \ i = 1, 2, 3 \) and the electric

\(^{1}\)With \( \sigma = 0 \) as an insulating material.
potential \( \phi \)—are approximated in each element through linear sums of interpolation functions (shape functions):

\[
\begin{aligned}
\mathbf{u}(\mathbf{r}) &= \sum_{j=1}^{n} a_{ij} N_j(\mathbf{r}), \quad i = 1, 2, 3, \\
\phi(\mathbf{r}) &= \sum_{j=1}^{n} b_{ij} N_j(\mathbf{r}), \quad \mathbf{r} \in V_e.
\end{aligned}
\]  

(7)

Here \( \mathbf{r} = (x_1, x_2, x_3)^T \) is the position vector, \( n \) is the number of specific so-called “node points” of the element, and \( a_{ij} \) and \( b_{ij} \) are the displacement and electrical degrees of freedom (DOF), respectively. The DOFs are the unknowns, whose values finally result from the solution of the FEM equations.

In (7), \( N_j(\mathbf{r}) = N_j(x_1, x_2, x_3) \) are the shape functions (chosen to be polynomials) associated with the element, and they satisfy the interpolation property

\[
N_j(\mathbf{r}_i) = N_j(x_{i1}, x_{i2}, x_{i3}) = \delta_{ij}, \quad i, j = 1, \ldots, n
\]  

(8)

where \( \mathbf{r}_i \) is the location of node point \( i \), and \( \delta_{ij} \) is the Kronecker delta. This implies that the DOFs equal the values of the field variables at the nodes.

In matrix form, (7) may be expressed as

\[
\begin{bmatrix}
u_i \\
\phi_i
\end{bmatrix} = \begin{bmatrix}
\mathbf{a}_i \\
\mathbf{b}_i
\end{bmatrix} =  \sum_{j=1}^{n} \begin{bmatrix}
a_{ij} \\
b_{ij}
\end{bmatrix} N_j(\mathbf{r}), \quad i = 1, 2, 3,
\]  

(9)

where \( \mathbf{N}_u(\mathbf{r}) \) and \( \mathbf{N}_p(\mathbf{r}) \) are matrices of shape functions and \( \mathbf{a} \) and \( \mathbf{b} \) are the column vectors of mechanical and electrical DOFs, respectively.

B. Finite Element Equations

The element equations in matrix form are [4], [31], [38]

\[
\begin{bmatrix}
k_{uu} & k_{u\phi} \\
\kappa_{u\phi} & k_{\phi\phi}
\end{bmatrix}
\begin{bmatrix}
\mathbf{a} \\
\mathbf{b}
\end{bmatrix}
+ \begin{bmatrix}
m_{uu} & 0 \\
0 & 0
\end{bmatrix}
\begin{bmatrix}
\dot{\mathbf{a}} \\
\dot{\mathbf{b}}
\end{bmatrix}
= \begin{bmatrix}
\hat{\mathbf{F}}_u + \hat{\mathbf{F}}_\phi + \hat{\mathbf{F}}_p \\
\hat{\mathbf{Q}}_u + \hat{\mathbf{Q}}_\phi + \hat{\mathbf{Q}}_p
\end{bmatrix}
\]  

(10)

where

\[
\begin{aligned}
k_{uu} &= \int_e B_u^T c_B u dV \\
k_{u\phi} &= \int_e B_u^T B_\phi dV \\
k_{\phi\phi} &= -\int_e B_\phi^T \varepsilon B_\phi dV \\
m_{uu} &= \int_e \rho N_u^T N_u dV \\
g_{uu} &= \int_e B_u^T \eta B_u dV \\
\hat{\mathbf{F}}_u &= \int_e \mathbf{N}_u^T \mathbf{f}_p dS \\
\hat{\mathbf{F}}_\phi &= \int_e \mathbf{N}_\phi^T \mathbf{f}_p dS \\
\hat{\mathbf{Q}}_u &= -\int_e \mathbf{N}_u^T \sigma dV \\
\hat{\mathbf{Q}}_\phi &= -\int_e \mathbf{N}_\phi^T \sigma dV
\end{aligned}
\]  

Here, \( \mathbf{f}_p \) is the mechanical point force at position \( \mathbf{r}_{pj} \), \( \sigma_{pj} \) is the point charge at the position \( \mathbf{r}_{pq} \), \( \mathbf{t}_n = (\sum_{j=1}^{3} T_{ij} n_j, \sum_{j=1}^{3} T_{ij} n_j, \sum_{j=1}^{3} T_{ij} n_j)^T \) is the mechanical surface force (the traction) \( (T_{ij} \) is the stress tensor element and \( n_j \) is the jth component of the unit outward normal to the element boundary), and \( q = -D_n = -D_n n_j \) is the inward-normal component of the electric displacement on the element boundary. In (11), the definitions \( \mathbf{B}_u = \nabla \phi \mathbf{N}_u \) and \( \mathbf{B}_\phi = \nabla \mathbf{N}_\phi \) are used. The frequency-dependent mechanical damping is introduced through damping matrix \( g_{uu} \), where \( \eta \) denotes the viscosity matrix \([Ns/m^2] \) [39]. Alternatively, frequency-independent mechanical, electric, and piezoelectric losses may be modeled by using complex material constants [40], [41].

These equations apply for each element. The equations describing the whole system, the so-called system equations, are assembled by evaluating contributions of the form of (10) and (11) from each element and adding each matrix element to the appropriate location in the global mass, mechanical stiffness, piezoelectric, dielectric, and damping matrices. The assembly of the system equations is, effectively, the enforcement of continuity of the solution at the interelement boundaries [1]. The form of the resulting linear system of equations to be solved, describing the
whole system, is the same as that of (10). For a mesh with 
N nodes, the total number of equations is 4N, with N 
equations for each field variable.2

C. Boundary Conditions

On the entire boundary of the domain (S in Fig. 2), one 
needs to define either a natural or an essential boundary 
condition (BC). For the mechanical quantities, these are 
expressed, respectively, as

\[
(t_n)_i = \sum_{j=1}^{3} T_{ij} n_j - \sum_k (f_{pk}) \delta (r - r_{pk}) = (\bar{t}_n)_i 
\]

or

\[
u_i = \bar{\nu}_i \text{ on } S \quad (13)
\]

Here, \( f_{pk} \) is the mechanical point force at position \( r_{pk} \) on 
the surface \( S \) and \( \delta \) is the Dirac delta function. The sum 
\( k \) is over the point forces. Furthermore, \( \bar{\nu}_i \) and \( (\bar{t}_n)_i \) (with 
\( i = 1, 2, 3 \)) are the prescribed components of displacement 
and surface traction, respectively, and \( n_i \) denote the 
components of the unit outward normal to the domain 
boundary.

The electrical BCs are expressed through

\[
q = -\sum_{j=1}^{3} D_j n_j - \sum_k \rho_{pk} \delta (r - r_{pk}) = \bar{D}_n 
\]

or

\[
\phi = \bar{\phi} \text{ on } S \quad (15)
\]

where \( \bar{\phi} \) is the prescribed potential, and \( \rho_{pk} \) denotes the 
point charge at position \( r_{pk} \) on the surface \( S \). The sum 
\( k \) is over the point charges. On the dielectric part of 
the boundary (\( S_R \) in Fig. 2), \( \bar{D}_n \) is the prescribed inward normal 
component of the electric displacement. On the part 
of the piezoelectric material boundary covered with 
electrodes, \( \bar{D}_n \) is replaced with the prescribed surface charge 
density \( \bar{\sigma} \).

In the 2D case, the field variables are assumed independent 
of the \( x_2 \)-direction, i.e., we are considering straight- 
crested waves. Hence, the 2D case is obtained readily 
by setting all of the derivatives with respect to \( x_2 \) to 0 
\( \left( \frac{\partial}{\partial x_2} \equiv 0 \right) \) and replacing the volume and surface integrals, 
respectively, with surface and line integrals. The line integral 
then extends over the boundary of the element in the 
counter-clockwise direction. In addition, in 2D modeling, 
we usually take the \( x_2 \) displacement to vanish such that 
the motion is in the plane only.

2 Application of the essential boundary conditions is implemented 
through appropriate manipulation of the matrices in the system 
equations involving the removal of matrix rows and columns. Hence, 
the number of equations to be finally solved is usually less than \( 4N \).

III. Harmonic Analysis

For the time harmonic case, sinusoidal variation of the 
physical quantities is assumed, i.e., \( a, b \propto e^{i\omega t} \). Then, after 
application of the BCs, the resulting system equations may be represented by

\[
\begin{bmatrix}
K_{uu} & K_{u\sigma} & K_{uF} & K_{uQ} \\
K_{\sigma u} & K_{\sigma\sigma} & K_{\sigmaF} & K_{\sigmaQ} \\
K_{F u} & K_{F\sigma} & K_{FF} & K_{FQ} \\
K_{Q u} & K_{Q\sigma} & K_{QF} & K_{QQ}
\end{bmatrix}
\begin{bmatrix}
a \\
\alphaF \\
\alphaF \\
\alphaQ
\end{bmatrix}
= \omega^2
\begin{bmatrix}
M_{uu} & 0 & 0 & 0 \\
0 & 0 & 0 & 0 \\
0 & 0 & 0 & 0 \\
0 & 0 & 0 & 0
\end{bmatrix}
\begin{bmatrix}
a \\
\alphaF \\
\alphaF \\
\alphaQ
\end{bmatrix}
\]

\[
+ i\omega
\begin{bmatrix}
G_{uu} & 0 & 0 & 0 \\
0 & G_{\sigma\sigma} & 0 & 0 \\
0 & 0 & G_{FF} & 0 \\
0 & 0 & 0 & G_{QQ}
\end{bmatrix}
\begin{bmatrix}
a \\
\alphaF \\
\alphaF \\
\alphaQ
\end{bmatrix}
= \begin{bmatrix}
F \\
Q \\
F \\
Q
\end{bmatrix}
\]

(16)

The FEM equations in (16) are partitioned such that those 
rows and columns corresponding to DOFs with an essential 
BC imposed are grouped together (submatrices with 
subscripts \( F \) and \( Q \)). The column vectors of prescribed 
nodal displacement and potential are \( \alphaF \) and \( \alphaQ \), respectively. 
The column vectors \( F \) and \( Q \), respectively, are those 
of mechanical force and electric charge. From the first two equations, 
the FEM equations to be solved may be expressed compactly as

\[
[K - \omega^2 M + i\omega G] x = F_{ho}
\]

(17)

where

\[
K = \begin{bmatrix}
K_{uu} & K_{u\sigma} \\
K_{\sigma u} & K_{\sigma\sigma}
\end{bmatrix}, 
M = \begin{bmatrix}
M_{uu} & 0 \\
0 & 0
\end{bmatrix}, 
G = \begin{bmatrix}
G_{uu} & 0 \\
0 & 0
\end{bmatrix}, 
F_{ho} = \begin{bmatrix}
F \\
Q
\end{bmatrix}, 
\] 
\[
\alphaF = \begin{bmatrix}
\alphaF \\
\alphaF
\end{bmatrix}, \quad x = \begin{bmatrix}
a \\
\alphaF
\end{bmatrix}, \quad \text{and}
\]

\[
F = \begin{bmatrix}
K_{uF} & K_{uQ} \\
K_{F u} & K_{F\sigma}
\end{bmatrix}, 
Q = \begin{bmatrix}
K_{\sigmaF} & K_{\sigmaQ} \\
K_{Q u} & K_{Q\sigma}
\end{bmatrix}, 
\alphaQ = \begin{bmatrix}
\alphaQ \\
\alphaQ
\end{bmatrix}
\]

(18)

The electromechanical stiffness matrix \( K \) is indefinite; the 
mass matrix \( M \) is positive semidefinite [42].

In harmonic analysis, (17) is solved for the unknowns 
\( x \)—the displacement and potential DOFs at the given 
frequency \( \omega \). From the solution, the element stress and 
electric displacement may be further obtained as

\[
T = c_{B_u} a + e^T B_\sigma b 
\]

(19)

\[
D = e_{B_u} a - e B_\sigma b, 
\]

(20)

respectively.

A. Admittance

The admittance \( Y \) is obtained through dividing total 
charge \( Q \) on an electrode by the amplitude of the driving 
voltage \( V \):

\[
Y(\omega) = \frac{i\omega Q}{V}
\]

(21)
The total charge on the electrode is computed as a sum of nodal charges. Inserting the solved DOFs into (16), the so-called vector of reactions $[F_F^T Q_u^T]^T$ is obtained. Here, $F_F$ is the nodal force at the nodes with fixed displacement, and $Q_u$ is the nodal charge at nodes with fixed potential. The total charge on a given electrode is computed through summing the nodal charges:

$$Q = -I_d^T Q_u$$  \hspace{1cm} (22)

where $I_d$ is a vector with unity at positions corresponding to those electrical DOFs that belong to the given electrode, and zeros elsewhere. The minus sign results from the definition of the current as positive into the piezoelectric body.

Computing the frequency response (e.g., admittance vs. frequency) requires the solution of the FEM equations at each of the desired frequencies. An alternative approach exploits the fact that the solution can be represented through a superposition of only a limited number of relevant modes that are excited in the frequency range considered [1], [43]. This approach involves the solution of the natural frequencies of the structure and the associated eigenmodes and is described in the next section.

IV. Modal Analysis

In modal analysis, the generalized piezoelectric eigenvalue problem formed by setting the load vector $b$ and damping matrix $G$ equal to zero in (17) is solved for the eigenpairs, i.e., eigenvalues (resonance frequencies) and eigenvectors (mode shapes). We consider mainly the case of voltage loading, i.e., one electrode is electrically grounded, and a sinusoidal voltage with prescribed constant amplitude is connected between the grounded and “hot” electrode. Solution of the eigenvalue problem then results in series resonance frequencies (short-circuited electrodes) at which the electrical impedance assumes low values. The parallel resonance frequencies with large values of impedance can be obtained from the open-circuited case [30], [44]. For the open-circuit boundary conditions, the potential is set constant on the “hot” electrode, but not fixed (floating potential).

In practice, because of increased computing times, it is not possible to solve for all of the eigenpairs for large problems. Instead, the modes are only computed in the frequency range of interest, e.g., in the vicinity of the fundamental thickness extensional mode. Because only part of the modes are taken into account, the electrical and mechanical responses obtained with modal analysis are approximations of those computed with the harmonic analysis.

The piezoelectric material between the two electrodes also forms a waveguide for electromagnetic waves. The assumption of a uniform potential on the electrodes implies that 1) the frequencies are low enough, such that the wavelength of the EM wave propagating in the waveguide is much larger than the lateral dimensions of the resonator and 2) the electrode is a perfect conductor.

A. Generalized Piezoelectric Eigenvalue Problem

The derivation of the subsequent equations closely follows that in [45]. Assuming harmonic motion and no damping, (16) takes the form

$$
\begin{pmatrix}
K_{uu} & K_{u0} & K_{u0} \\
K_{0u} & K_{00} & K_{00}
\end{pmatrix} - \omega^2
\begin{pmatrix}
M_{uu} & 0 & M_{u0} \\
0 & 0 & 0
\end{pmatrix}
\begin{pmatrix}
a \\
b
\end{pmatrix}
= 
\begin{pmatrix}
F \\
Q
\end{pmatrix}
$$  \hspace{1cm} (23)

where, using the submatrices in (16),

$$
K_{u0} = [K_{uF} K_{uQ}] \\
K_{00} = [K_{0F} K_{0Q}]
$$

and

$$
M_{u0} = [M_{uF} M_{uQ}]
$$

In (23), $F_R$ is the vector of reactions. The first two equations in (23) may be written as

$$
\begin{pmatrix}
K_{uu} & K_{u0} \\
K_{0u} & K_{00}
\end{pmatrix} - \omega^2
\begin{pmatrix}
M_{uu} & 0 \\
0 & 0
\end{pmatrix}
\begin{pmatrix}
a \\
b
\end{pmatrix}
= 
\begin{pmatrix}
F_0 \\
Q_0
\end{pmatrix}
$$  \hspace{1cm} (25)

where

$$
\begin{pmatrix}
F_0 \\
Q_0
\end{pmatrix} = 
\begin{pmatrix}
F \\
Q
\end{pmatrix} - 
\begin{pmatrix}
K_{uu} & K_{u0} \\
K_{0u} & K_{00}
\end{pmatrix} - \omega^2
\begin{pmatrix}
M_{uu} & 0 \\
0 & 0
\end{pmatrix}
\begin{pmatrix}
a \\
b
\end{pmatrix}
$$  \hspace{1cm} (26)

is the equivalent load that converts the applied displacement and voltage loading to mechanical force and electrical charge on the nodes of the FEM mesh. The associated generalized eigenvalue problem is

$$
\begin{pmatrix}
K_{uu} & K_{u0} \\
K_{0u} & K_{00}
\end{pmatrix} u
- \omega^2
\begin{pmatrix}
M_{uu} & 0 \\
0 & 0
\end{pmatrix} u
= [\Omega]^2 u
$$  \hspace{1cm} (27)

where $u = [u_u^T u_0^T]^T$ is the matrix of eigenvectors (mode shapes) corresponding to the mechanical DOFs; $[\Omega]^2$ denotes the diagonal matrix of the corresponding eigenvalue spectrum. The electrical DOFs have zero mass and, consequently, infinite eigenvalues associated with them [45]; the eigenvectors corresponding to electrical DOFs may be neglected. The eigenvectors are normalized:

$$
u_u^T M_{uu} u_u = 1: 
\begin{pmatrix}
u_u \\
u_0
\end{pmatrix}^T
\begin{pmatrix}
K_{uu} & K_{u0} \\
K_{0u} & K_{00}
\end{pmatrix}
\begin{pmatrix}
u_u \\
u_0
\end{pmatrix} = [\Omega]^2.$$

$\hspace{1cm}$

The unknown mechanical and electrical DOFs at the frequency $\omega$ can be expressed in terms of the solved eigenvectors and eigenvalues.

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3The piezoelectric material between the two electrodes also forms a waveguide for electromagnetic waves. The assumption of a uniform potential on the electrodes implies that 1) the frequencies are low enough, such that the wavelength of the EM wave propagating in the waveguide is much larger than the lateral dimensions of the resonator and 2) the electrode is a perfect conductor.
B. Mechanical and Electrical Response

For voltage excitation, one electrode is grounded, and a potential \( \varphi \) is imposed on the “hot” electrode. Then, the displacement vector may be written as

\[
a = \sum_{j=1}^{n} \frac{u_{n_j} \varphi H_j}{\omega_j^2 - \omega^2 + i\eta_j \omega_j^2},
\]

and the potential vector may be written as

\[
b = \sum_{j=1}^{n} \frac{u_{\phi_j} \varphi H_j}{\omega_j^2 - \omega^2 + i\eta_j \omega_j^2} + K_{\phi \phi}^{-1} Q_0.
\]

In (29) and (30), \( u_{n_j} \) and \( u_{\phi_j} \) are, respectively, the mechanical and electrical parts of the eigenvector corresponding to the eigenvalue \( \omega_j \), and

\[
H_j = \frac{1}{\varphi} \begin{bmatrix} u_{n_j}^T \\ u_{\phi_j}^T \end{bmatrix} \begin{bmatrix} F_0 \\ Q_0 \end{bmatrix}.
\]

In the denominators of (29) and (30), damping is introduced through term \( i\eta_j \omega_j^2 \), where \( \eta_j \) describes the strength of damping in mode \( j \).

Inserting \( a \) and \( b \) into (23), \( F_R \), the column of reactions, can be computed. The total charge on the electrode at the potential \( \varphi \) is obtained through summing the nodal charge: \( Q_T = -\mathbf{I}_Q^T F_R \), where \( \mathbf{I}_Q \) is a row vector with unity at the positions corresponding to the electrical DOFs associated with nodes on the electrode at the potential \( \varphi \) and zeros elsewhere. The admittance may be expressed as

\[
Y(\omega) = \sum_{j=1}^{n} \frac{i\omega M_j}{\omega_j^2 - \omega^2 + i\eta_j \omega_j^2} + i\omega C_p
\]

where the modal constants \( M_j \), defined as

\[
M_j = -\mathbf{I}_Q^T [K_{n0}^T K_{\phi0}^T] \begin{bmatrix} u_{n_j} \\ u_{\phi_j} \end{bmatrix} H_j,
\]

indicate the contribution of mode \( j \) to the electrical response [45], [46]. The shunt capacitance \( C_p \) is given by

\[
C_p = -\frac{1}{\varphi} \mathbf{I}_Q^T [K_{n0} e_0 + K_{\phi0}^T K_{\phi0}^{-1} Q_0].
\]

For the case \( F = Q = 0 \) in (23) and with the prescribed values of mechanical DOFs in the vector \( e_0 \) equal to zero, one obtains \( M_j = H_j^T \). As already mentioned, the admittance in (32) approximates that obtained using the harmonic analysis approach in the case that only part of the modes are included in the sum, i.e., if \( n < N_u \), where \( N_u \) is the total number of free mechanical DOFs (number of elements in the column vector \( a \)). The same holds for the solved displacement and potential in (29) and (30), respectively.

C. Equivalent Circuit Representation

Consider the extended Butterworth Van Dyke lumped element equivalent circuit of a BAW resonator [20] shown in Fig. 3. Each branch contains a resistor, an inductor, and a capacitor, representing a resonance in the frequency response of the resonator. The admittance of the equivalent circuit is

\[
Y(\omega) = \sum_{j=1}^{n} \frac{i\omega}{L_{mj} C_{mj}} - \omega^2 + i\omega \frac{R_j}{L_{mj}} + i\omega C_p.
\]

Defining the unloaded quality factor of the series resonance as \( Q_s j = 1/(\omega_j C_{mj} R_j) \) [20], gives \( R_j/L_{mj} = \omega_j/Q_s j \). Comparing (32) and (35) allows one to express the equivalent circuit elements in terms of the FEM modal analysis parameters:

\[
C_{mj} = M_j \omega_j^2
\]

\[
L_{mj} = \frac{1}{M_j}
\]

\[
R_j = \frac{\omega_j \eta_j}{M_j}, Q_{s j} = \frac{1}{\eta_j}
\]

\[
\omega_j = \frac{1}{\sqrt{L_{mj} C_{mj}}}
\]

The intensity of modes is commonly evaluated using the effective piezoelectric coupling coefficient [38], [42]:

\[
k_{eff j} = \sqrt{\frac{\omega_j^2 - \omega_{pj}^2}{\omega_j^2}}
\]

with \( \omega_{pj} \) and \( \omega_j \), respectively, denoting the parallel and series resonance frequencies (antiresonance and resonance frequencies). In the idealized case of only one excited mode, say mode \( j \), the parallel resonance frequency \( \omega_{pj} \)
can be found by omitting other terms in the sum appearing in (32), except the one corresponding to mode \( j \), and setting the admittance equal zero. Omitting the damping factor yields

\[
\omega_{pj} = \sqrt{\frac{\omega_j^2}{\omega_j^2} + \frac{M_j}{C_p}}.
\]

(41)

Substitution into (40) leads to

\[
k_{eff,j} = \sqrt{\frac{C_{mj}}{C_p}} = \sqrt{\frac{M_j}{\omega_j^2 C_p}},
\]

(42)

relating the effective coupling constant \( k_{eff,j} \) and modal constant \( M_j \).

V. Computer Implementation

The main features of our FEM software are 1) the use of 2D quadrilateral elements with cubic and 3D brick elements with quadratic interpolation polynomials for improved accuracy of the results, 2) skyline storage scheme utilizing the characteristic sparse structure of the consistent mass matrix, and 3) use of the spectral transformation Lanczos method for efficient solution of the generalized piezoelectric eigenvalue problem. For creation of 2D resonator models, we have developed a separate preprocessor program. For 3D models, the computational mesh needs to be created using a commercial preprocessor program. The 3D FEM meshes of resonators modeled in this paper are created using the preprocessor of the commercially available ANSYS software. For the postprocessing, e.g., visualization of the computed fields and mode shapes, postprocessing programs both for 2D and 3D geometries have been coded. The software is implemented in the C language, although it uses several numerical subroutine libraries programmed in Fortran (such as BLAS, LAPACK, and ARPACK [47]).

Our FEM solver is based on the approach of [1], which is extended appropriately to model piezoelectric materials. The integrals in the element equations (10) are evaluated numerically using Gauss-Legendre quadrature. The order of quadrature may be chosen in the range from 1 to 5. Currently, for 2D modeling, quadrilateral elements up to cubic and, for 3D modeling, linear and quadratic brick elements have been implemented. All of the elements are of serendipity type, i.e., the nodes are located on the boundary of the element. The shape functions are mapped from the parent element on real elements in the actual mesh (isoparametric elements), allowing for curved element boundaries. The vectors required for the computation of the reactions, e.g., \( \mathbf{I}_Q^T [K_{Q0} K_{Q0}] \) and \( \mathbf{I}_Q^T K_{Q0} \) in (33) and (34), respectively, are computed at the assembly phase without need to form the full matrices in (16) and (23). The materials properties are defined through the full stiffness, piezoelectric, dielectric, and viscosity constant matrices. In harmonic analysis, local non-uniform damping may be modeled by spatially varying the viscosity constants.

The application of essential BCs involves modification of the right-hand side in the system equations, as is evident in (18) and (26). The rows and columns associated with the DOFs, where an essential BC is imposed, may be removed from the matrix equations to be solved. The program allows for sets of nodes to be coupled, i.e., a specified field variable is forced to assume the same value on the coupled nodes. Then, all but one of the corresponding DOFs may be eliminated from the system equations, thus slightly reducing the computational task. After the solution, the value obtained for one remaining DOF is copied to the rest of the DOFs in the coupled set. This is convenient, e.g., in defining the driving voltage between two electrodes under the assumption that the potential does not vary over the electrode. Also, configurations involving electrodes without a fixed potential, such as monolithic crystal filters and stacked crystal filters [17] can be modeled. Floating electrodes are treated by coupling the potential of the nodes belonging to the electrode but leaving the value of the potential undetermined; the electrode potential is obtained via the solution of the FEM equations.

A. Skyline Matrix Storage Scheme

The FEM matrices in (17) and (23) are sparse, symmetric, and banded, i.e., most of the elements equal zero, and the nonzero elements are grouped close to the diagonal of the matrix. This results from the local connectivity property of the FEM, as opposed to the global connectivity, e.g., in boundary element method, which leads to dense matrices. The assembly of the global FEM matrix from the element contributions is illustrated in Fig. 4. Because there are four field variables to be considered, each node corresponds to four rows and columns in the FEM matrices. Node \( i \) is connected to all of the nodes in those elements that share node \( i \). Hence, in the example shown in Fig. 4, e.g., node 13 is connected to nodes 1–8, 12, 14–15, 17, 18, 20, 21, and 28–31, resulting in non-zero elements at locations shown in dark gray. Because of symmetry, it suffices to save only the upper or lower triangular part.

The sparsity structure of the electromechanical stiffness matrix \( \mathbf{K} \) is shown in an expanded view of Fig. 5. In the conventional skyline (envelope) scheme applied to the stiffness matrix, the elements in each column are stored from the diagonal element until the last non-zero element above the diagonal. For the mass matrix, a modified scheme [48] is utilized that exploits its specific structural pattern shown in Fig. 6. The non-vanishing elements are located on the diagonals of \( 3 \times 3 \) submatrices; most of the zeros inside the envelope are not stored. The reduction in the number of the stored elements also reduces the number of computational operations, resulting in savings in the execution time.

To minimize the execution time and memory requirements, it is essential to arrange the DOFs in the FEM equations such that the number of elements within the
skyline (matrix profile) is minimized. Prior to the assembly of the system matrices, the node numbering and/or order of the DOFs in the \( K \) matrix are optimized with respect to the matrix profile using the Gibbs-King algorithm [49].\(^4\) The effect of optimization of the node numbering using the Gibbs-King algorithm on the structure of the electromechanical stiffness matrix \( K \) is plotted in Fig. 7 and 8, showing the significant reduction in the matrix profile.

**B. Solution of Generalized Eigenvalue Problem**

In the modal analysis, the eigenvalues and eigenvectors of the generalized piezoelectric eigenvalue problem resulting from the FEM formulation are solved using a variant of the Lanczos algorithm, as implemented in the numerical ARPACK library [47]. The efficiency of the method results from the fact that the algorithm retains the banded sparse structure of the stiffness matrix, in contrast to the conventional method, which uses a static condensation technique [4], [30] to eliminate the electric potential DOFs from the equations prior to the solution of the eigenvalue problem [48]. The spectral transformation Lanczos algorithm computes the given number of eigenpairs whose eigenvalues are in the vicinity of a given limit \( \omega_0^2 \). Before the iteration starts, the matrix \( K - \omega_0^2 M \) is formed and factored. In the iteration process, the two major operations required are 1) solution of a linear system of equations with the factored coefficient matrix and 2) multiplication of the mass matrix with a vector.\(^5\) The solution technique used allows for an efficient computation of the resonance frequencies (eigenvalues) and mode shapes (eigenvectors), especially for resonator configurations that involve narrow matrix bandwidths [50]. This is the case for 2D models of the thin and wide BAW composite resonator structures considered here.

**VI. FEM SIMULATIONS OF THIN-FILM RESONATORS**

We apply the FEM modeling software to the analysis of the vibration characteristics of membrane type thin-film resonator configurations. The response of the resonator considered is characterized by using the modal analysis approach to compute the resonant frequencies, displacement profiles, and excitation strengths of the modes in the vicinity of the fundamental thickness extensional mode. In thin-film resonators, the thickness of electrodes can be significant in comparison with the total thickness of the resonator. Consequently, ignoring the electrodes or including them in the model merely as additional mass loading, as is done in various plate theories for piezoelectric resonators [36], [37], may result in an inaccurate description. More-

\(^4\)The DOF ordering shown in Fig. 4, 5, and 6 is that before the optimization.

\(^5\)In the Lanczos method described in [48], [50], Cholesky factorization of the mass matrix is required. This will retain the structure of the mass matrix shown in Fig. 6, but many of the zeros on the diagonals of those \( 3 \times 3 \) submatrices, which are inside the envelope, would be replaced by non-zero elements. Because a factorization of the mass matrix is not required here, the storage method of the mass matrix could be further improved through saving only the non-zero elements. In this case, e.g., the elements at positions 362, 373, and 384 in Fig. 6 would not be saved.
Fig. 5. Sparsity structure of the stiffness matrix. Black squares denote possible nonzero elements. Numbers refer to the position in the vector storing the matrix elements in the skyline scheme. The row and column labels identify the field variables: the displacements \((x, y, z)\) and electric potential \((p)\). The subscript refers to the node number.

Fig. 6. Structural pattern of the mass matrix; for explanation, see Fig. 5.

Fig. 7. Skyline of the \(K\) matrix for a 3D FE model without optimization of the node numbering.

Fig. 8. Skyline of the \(K\) matrix for a 3D FE model with optimization of the node numbering using the Gibbs-King algorithm.
A. Comparison of 2D and 3D Simulations

over, the support layers in membrane configurations and
the layers in the acoustic mirror in SMR are comparable
with the thickness of the piezoelectric. The situation is
similar to ultrasonic transducers with matching and back-
ing layers. For their modeling, 3D FEM is widely used
[6], [38]. However, the 3D FEM can be computationally
exceedingly intensive. To reduce the computational load,
laminated plate theories have been suggested for the mod-
ing of thin-film resonators [51], [52], involving the reduc-
tion of the 3D equations into 2D through integration over
the thickness direction. However, the plate theories pro-
vide accurate results only for certain modes within limited
frequency ranges. Therefore, we use full 3D FEM, but with
relatively coarse meshes to reduce the required computa-
tional costs.

For accurate results, a sufficient number of nodal points
per wavelength in the highest mode of interest needs to be
used in the computational mesh—the number decreases
with increasing order of interpolating polynomials used for
the element. Choosing the number of elements in the thick-
ness direction such that the thickness mode is accurately
modeled and keeping the element aspect ratio small would
require a large number of elements in the lateral directions
because of the thin and wide structure of the thin-film
resonators. However, because of the relatively large lat-
eral wavelength of the anharmonic thickness extensional
modes close in frequency to the fundamental mode, rela-
tively coarse element division in the lateral direction can
be used. The higher order elements are less affected by
the large element aspect ratios, and, in our simulations
with quadratic 3D elements, no numerical problems were
encountered.

A. Comparison of 2D and 3D Simulations

First, we study the resonator reported by Milsom et al.
[53], which they have modeled with the mode-matching
method. The 2D cross-section of the resonator configura-
tion is shown in Fig. 9. Because of symmetry, in 3D mod-
eling, it suffices to perform the computations using only
one quadrant of the actual resonator and to impose ap-
propriate boundary conditions on the symmetry planes.
Simulations in 3D are carried out with 20-node quadratic
3D brick elements. The element division in the lateral di-
rections is regular 14 x 14 elements per side. The number
of elements in the thickness (z) direction in the Si, Al,
ZnO, and Al layers is 1, 1, 2, and 1, respectively, with the
largest element aspect ratio in the mesh being 125. In 2D
simulations, plane-strain elements are employed, i.e., the
y dimension is assumed infinite. Air loading is neglected,
and the models are truncated on the edges of the membrane,
demonstrating one of the shortcomings of FEM—the diffi-
culty in modeling open boundary problems. Several tech-
niques have been proposed for alleviating this problem,
such as the infinite element approach [54], [55]. In har-
monic analysis, the effect of the wave reflections from the
model edges can be reduced by introducing a region with
strong damping at the membrane edges. Here, we simply
impose zero displacements on the artificial boundary re-
sulting from the truncation, which is an approximation to
the actual BC. However, this introduces only minor mod-
eling errors in case of trapped modes, where the displace-
ments on the boundary are negligible. The potential of the
upper electrode is assigned the value 1 V, and the bottom
electrode is grounded. On the non-metalized boundaries
of the problem domain, the BC $D_n = 0$ is implicitly as-
sumed (no electric flux leakage). Actually, $D_n$ should be
continuous across the non-metalized part (for insulating
materials) of the boundary rather than zero. However, the
approximation is fair for piezoelectric materials with either
a weak piezoelectric coupling (as for quartz) or a high di-
electric constant [22]. For certain geometries, materials,
and modes, flux leakage acts to slightly decrease the reso-
nance and antiresonance frequencies, but can affect more
considerably the effective coupling coefficient of the mode
[c.f. (40)] [42]. The resonator model is always an idealiza-
tion of the actual structure, which can feature imperfec-
tions affecting the resonator behavior. Moreover, as FEM
derives the device behavior directly from the device geom-
etry and materials constants, the accuracy of the results
also depends on the precision to which these parameters
are known.

The modal constants in (33) together with the admit-
tance in (32), computed for the 2D and 3D models are
displayed in Fig. 10 as a function of frequency. It is seen that
the fundamental thickness extensional mode, with large
average displacement in the z direction at the frequency
221.3 MHz in the 2D case and 221.8 MHz in the 3D case,
is most strongly excited. The frequency of the main reso-
nance computed with the 3D model is slightly higher than
that computed with the 2D model because of the low num-
ber of elements in the thickness direction used in the 3D
model—the result is not quite fully converged. Several ad-
ditional responses or side resonances can be recognized in
the vicinity of the main resonance. The unwanted modes
present in the frequency response degrade the usability of
the resonator. Above the main resonance frequency, the
weaker spurious modes are associated with the anharmonic
thickness extensional modes (resonances in the lateral di-
rection caused by reflections of Lamb waves on the edges
of the electrode [56]). The generation of the plate waves
can be attributed to the electrode edges. To satisfy the BC
at the electrode edge, thickness extensional modes with a
non-vanishing lateral component of the wave vector are required. It is clearly seen, by comparing the 2D and 3D results, that the 2D model is not adequate to model the full anharmonic mode content; the 3D model predicts stronger and richer mode spectrum than the 2D model.

The various modes are characterized through their electric and mechanical field profiles. The mechanical field profile is obtained from the mechanical part of the eigenvector. The mode shapes at the main resonance and at selected spurious resonances for the 2D model are shown in Fig. 11. The displacement profiles [computed with (29)] obtained with 3D simulations are plotted at selected resonances in Fig. 12. For the mode in Fig. 11(c), the charge (current) distribution on the upper electrode is also displayed. The electrode effectively integrates the current distribution, resulting in an average current [21]. Hence, the modes with a net current distribution summing up to zero cannot be excited by the applied voltage loading, e.g., in the 2D case, the anharmonic thickness extensional modes with an even number of current (and displacement) maxima across the electroded region are not electrically excited. In other words, because of the symmetry of the resonator geometry, the applied loads, and the materials properties, only symmetric modes can be excited. Both the resonance frequencies and the mode shapes computed with the 2D FEM agree well with those predicted in [53].

All of the plotted modes exhibit energy trapping into the top electrode region, and, hence, the BC of zero displacement at the edges of the membrane is an accurate approximation. Because of the large width-to-thickness ratio of the resonator, Lamb waves propagating in infinite plates can be used to interpret the trapping of the modes. Because the resonance frequency of the mode is above the cut-off frequency of the associated Lamb wave mode for the electroded region, the wave can propagate in the electroded region in the lateral direction (the component of the wave vector in the lateral direction $k_x$ is real). However, the resonance frequency is below the cut-off frequency in the non-metalized region (imaginary lateral component of the wave vector), where an exponential decay of the wave amplitude results [57]. We have computed the cut-off frequencies of $\lambda/2$ thickness extensional mode to be 221.1 and 228.2 MHz in the metalized (short-circuited) region and non-metalized region, respectively. Because of the energy trapping, the loss mechanism associated with the Lamb waves carrying acoustic energy away from the resonator is suppressed, giving rise to low losses and high Q values.

### B. Influence of Top Electrode Shape

To investigate the effect of the top electrode shape on the resonator response, in general, full 3D simulations are required. Here, we consider the cases of square, circular, and irregular quadrilateral top electrodes (see also [58]). FEM is validated by comparing the simulated displacement profiles with those measured for SMR resonators with a laser interferometer [29]. The laser probe is described in detail in [59].

Each resonator model consists of a 400-nm thick molybdenum bottom electrode, a 2050-nm thick ZnO layer, and a 400-nm thick aluminum top electrode. The thickness of the ZnO layer is chosen such that the measured and simulated series resonance frequencies for the resonator with a square top electrode are equal. The top and bottom surfaces are stress free, and the edges of the plate are fixed. The distance from the electrode edge to the fixed plate edge for models with square and circular top electrodes is

---

**Fig. 10.** Modal constants and admittance vs. frequency computed with modal analysis for the 2D and 3D models of the membrane BAW composite resonator. The admittance computed with a 1D model cannot model the parasitic resonances.

**Fig. 11.** Modal displacement fields at the selected resonances for the modeled BAW resonator (left half; the right half is symmetric). The arrow marks the edge of the top electrode. The grayscale indicates the lateral displacement. For one of the modes (c), the current distribution in the top electrode is also plotted. The lateral and vertical dimensions are not to scale.
The area of the top electrode in all of the configurations is 40 000 \( \mu m^2 \).

The number of elements in the thickness (z) direction in the molybdenum, the ZnO, and the aluminum layers is 1, 3, and 1, respectively. The lateral discretizations in FEM for the resonators with square and circular top electrodes are shown in Fig. 13.

1. **Square Top Electrode.** The model covers one quadrant of the actual resonator, and the symmetry BC are imposed: \( x \)- and \( y \)-components of the displacement vector vanish on the \( yz \)- and \( xz \)-symmetry planes, respectively. The simulated and measured displacement profiles on the top surface of the resonator with square top electrode are plotted for several frequencies in Fig. 14. In the computation of the displacements, the quality factor (\( Q \)) of 1500 is used for all modes [i.e., \( Q_{sj} = 1500 \) in (38)]. This value yields appropriate separation of the modes to match the measured mode shapes. In Fig. 14 through 17, the gray scale is such that the largest normalized magnitude of the \( z \)-displacement in each figure is indicated in white, and the lowest one is indicated in black. Similar displacement profiles for resonators with AlN as the piezoelectric and rectangular top electrode have also been measured by other authors and have been obtained with the atomic-force-microscope-based technique [60] and by laser interferometry [61], [62]. The ripple with a short spatial period observed in the simulated and measured displacement profiles is attributed to the standing wave pattern of high order anharmonic thickness shear modes. The fundamental frequency of these modes is below the operational frequency of the resonator considered here. However, the resolution of the computational mesh in Fig. 14 is not adequate to accurately model waves of such short wavelengths.

2. **Circular Top Electrode.** The case of a circular top electrode is simulated both with quadratic 3D and 2D axisymmetric elements. The measured and simulated magnitudes of the \( z \)-displacements obtained with 3D elements and 2D axisymmetric elements are illustrated in Fig. 15. Here, a \( Q \)-factor of 1000 is used for all modes. The measured frequencies are somewhat lower than those simulated, because, most probably, the ZnO layer in the mea-
Fig. 14. Simulated (left) and measured (right) magnitudes of the 
$z$-displacements for the resonator with a square top electrode.

3. Quadrilateral Top Electrode with No Parallel Sides:
It is suggested in [63], that irregular top electrode shapes 
could decrease the strength of the spurious modes. To test 
for this, the electrical response of a resonator featuring 
quadrilateral top electrode with no parallel sides has been 
simulated. The lateral element division in the FEM mesh 
is shown in Fig. 16. The simulated magnitudes of the dis-
placement components in the $z$-direction on the top sur-
face of the resonator as functions of frequency are plot-
ted in Fig. 17. It is seen in Fig. 17(c, d, and e), that the 
mode with three displacement amplitude maxima across 
the electrode in the $y$-direction occurs first at the right-
hand end of the electrode. As the frequency increases and 
the wavelength decreases, this amplitude profile moves to-
ward the left, where the shorter electrode dimension in the 
$y$-direction is capable of supporting the mode. In Fig. 17(a, 
b, and f), regular displacement profiles are seen with $1 \times 1$, 
$2 \times 1$, and $4 \times 2$ vibration amplitude maxima in the $x$- and $y$-
directions, respectively, with the number in the $x$-direction 
given first.

The static capacitances computed with FEM are 
1.770 pF for the square; 1.764 pF and 1.755 pF for the 
circular top electrode configuration obtained with 3D el-
ements and 2D axisymmetric elements, respectively; and 
1.797 pF for the quadrilateral top electrode shape with 
no parallel sides. Fig. 18 shows the simulated frequency 
responses for the three top electrode geometries. Strong 
side resonances caused by anharmonic thickness exten-
sional modes are observed at frequencies above the fund-
amental thickness extensional mode (approximately at 
1060 MHz). Comparing the response of the irregular top 
electrode with those simulated for the square and circular 
top electrodes, it can be seen that, for the irregular top 
electrode, the onset of the strong side resonances occurs 
at a higher frequency, and the frequency spacing of the 
side resonances is larger. However, the response still shows 
spurious resonances with strengths approximately equal to 
those present in the responses simulated for square and 
circular top electrode shapes. Furthermore, the series res-
onance $Q$-factor in the case of the irregular top electrode 
can be seen to be slightly lower than in the cases of rect-
angular and circular top electrodes. Using 3D FEM, the 
shape of the top electrode can be easily varied to adjust 
the electrical response and to find a shape that minimizes 
the detrimental effects of the side resonances.

The discrepancies between the simulated and measured 
displacement profiles can be attributed mainly to the fol-
lowing effects.

- Fabrication inaccuracies, e.g., the actual resonator 
possesses a non-uniform piezoelectric layer thickness 
profile, whereas, in the FEM, all of the material lay-
ers have an ideal constant thickness. In addition, the 
material parameters are not accurately known.
- The simulated structure is a membrane-type res-
onator, rigidly supported at the plate edges, whereas
Fig. 15. Measured (middle row) and simulated magnitudes of displacement components in the $z$-direction for the resonator with a circular top electrode. In the 3D simulations (top row) and 2D simulations (bottom row), 20-node brick elements and 8-node quadrilateral axisymmetric elements are used, respectively. For the axisymmetric case, the top electrode edge is indicated with the white dashed line.

The actual resonator is an SMR configuration. Adding the acoustic mirror layers below the resonator would significantly increase the computational cost in the 3D case.

- The $Q$-factors of the modes in the measurements and simulations are unequal, resulting in different overlaps of the modes.
- A comparatively coarse lateral discretization is used in the 3D FEM models.

Although the aspect ratios for the 3D elements used were rather large (15.6, 31.3, and 59.2 for the square, circular, and irregular quadrilateral cases, respectively), the accuracy in the resonance frequencies of the anharmonic thickness extensional modes above the main resonance frequency is reasonable. This is seen by comparing the admittances computed for the circular top electrode configuration using both the 3D and axisymmetric elements.

Fig. 16. Lateral element divisions of the FEM mesh for the resonator with asymmetric top electrode. The edge of the top electrode is indicated with the thick line.
Fig. 17. Simulated magnitudes of displacement components in the $z$-direction as functions of frequency for the membrane resonator featuring quadrilateral top electrode with no parallel sides. In the computation of the displacements, a $Q$-factor of 1000 is used for all of the modes.

Fig. 18. Simulated admittances for resonators with various top electrode shapes obtained using FEM modal analysis (a $Q$-factor of 1000 has been used for all of the modes).

The computational parameters for the FEM simulations are displayed in Table I. The simulations were carried out with an SGI Origin 2000 computer. The execution times in Table I are only indicative, because they also depend on the total computational load in the multiuser environment. The effect of increasing the model size on the computing time in modal analysis is twofold. First, the execution time for solving each eigenpair increases. Second, the number of modes within a given frequency range of interest increases. For example, the 40 eigenpairs solved for model 5 in Table I spanned a bandwidth of 5.5 MHz.

VII. Conclusions

The FEM formulation for linear forced vibrations of piezoelectric media has been described. The harmonic analysis and modal analysis approaches to simulate the frequency characteristics of BAW resonators have been considered.

For the efficiency of the FEM modeling technique, the memory management method chosen and algorithms for
solving the linear system of equations (in the harmonic analysis) and generalized eigenvalue problem (in the modal analysis) are of fundamental importance. The skyline storage scheme exploiting the characteristic structure of the mass matrix is employed in the interest of efficient memory usage. Consequently, simulations with more refined meshes for higher accuracy or simulations with larger models are possible. The application of cubic elements in 2D simulations provides an improved accuracy of the solution with less computational load in comparison with lower degree elements.

In the modal analysis, the Lanczos eigensolver is utilized in the computation of the natural resonance frequencies and the corresponding mode shapes within a specified bandwidth. Its efficiency results from the preservation of the sparse structure for the piezoelectric stiffness matrix. Furthermore, the modal constants quantifying the excitation strength for each resonant mode are computed. Subsequently, the approximate electrical admittance response can be computed in terms of the modal constants.

The FEM is applied to a thin-film membrane BAW resonators. The phenomenon of energy trapping is demonstrated, and the origin of the spurious modes in the anharmonic thickness extensional modes is emphasized. Comparison of results from 2D and 3D FEM simulations shows that, for most geometries, accurate analysis of resonator response requires full 3D modeling. The electrical response (admittance) and the displacements for resonators with various top electrode shapes are simulated. For square and circular top electrodes, the simulations are validated against laser interferometric measurements; the simulated magnitudes of the displacement components in the thickness (z) direction are found to agree well with the measurements. This shows that, although accurate 3D FEM simulations of composite BAW resonators would require a dense FEM mesh, rendering the simulations computationally intensive, valuable qualitative information on the performance of the resonator can be obtained from simulations requiring only moderate storage space and computing time. This is particularly true for the anharmonic thickness extensional modes with relatively long spatial wavelength in the vicinity of the fundamental thickness extensional mode.

The FEM simulations serve to analyze proposed resonator configurations and enable their comparison with respect to electrical performance. The dependence of the undesired parasitic resonances on the device structure, design, and dimensions can be investigated to help in the resonator design. Effects of manufacturing inaccuracies on the resonator response can also be studied. Moreover, the predictions of models based on approximate equations [37, 52, 64] can be tested and validated against 3D FEM.

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Makkonen et al.: FEM simulations of bulk resonators.


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